

Semiconductors Driving Disruptive Innovations In Global Digitalization

## 08-12 Jan 2023

Venue - Novotel, HICC, Hyderabad

## Design Contest

Call for Submission 🚃			
ldea	Acceptance	Kit	Idea
Submission	Notification	Distribution	Presentation
<b>31</b>	<b>04</b>	<b>04</b>	<b>10</b>
Oct. 2022	Nov. 2022	Nov. 2022	Jan. 2023

# Call For Design Contest

The 38th International Conference on VLSI Design and the 22th International Conference on Embedded systems is holding the International Design Contest to provide a platform to showcase semiconductors driving disruptive innovations in global digitalization.

## Theme of the Contest

The theme of the Design Contest is Hardware and Embedded software co-design with hardware acceleration in an SoC FPGA. You will be showcasing design approaches and system solutions in the areas/domains of Al/ML, IoT, Factory & Industrial Automation, Automotive, Medical, Environment & Clean Energy

### Hardware Platform

The hardware platform will be Microchip Technology's RISC-V based PolarFire® SoC Icicle Kit. For details on the kit, please refer to the following external links:

PolarFire SoC Icicle Kit Hardware Kit: https://github.com/polarfire-soc



# Submission

## Stage-1: Idea Submission

- Your idea submission should cover a description of the idea along with a block diagram of your idea
- · Examples of it's application
- · Benefits and value addition of your solution
- Your team description along with your contact information with mailing address

#### Steps for the submission

- Download template available on the conference website.
- Fill all required details with minimum font size:
  10pt, times new roman font. Max two pages including tables, diagram, references (if any).
- · Convert it to pdf format.

Submit the pdf using the weblink available on conference website.

Following the first round of screening, 5 teams will be shortlisted to convert their ideas into application solution using the PolarFire SoC Icicle Kit Hardware kits will be shipped to selected teams

### Stage-2: Implementation

- Implementation should be on the Microchip Technology PolarFire SoC Icicle Kit provided.
- Experts from Conference team will guide and mentor during this 2 months of implementation.

